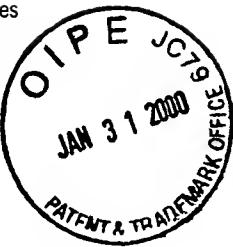


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on January 24, 2000
By LAWRENCE M. KAPLAN



8/B
Attorney Docket No. A-2-2

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:)
PHILIP E. EGGERST et al.) Examiner: L. Cohen
Application No.: 09/098,205) Art Unit: 3739
Filed: July 27, 1998)
For: SYSTEMS AND METHODS FOR)
ELECTROSURGICAL TISSUE)
TREATMENT IN CONDUCTIVE FLUID) AMENDMENT

Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the Office Action mailed November 15, 1999, please amend the above-identified application as follows.

IN THE SPECIFICATION:

On page 1, please delete the first paragraph (lines 8-21) and insert the following:

B
The present invention is a continuation-in-part of Application No. 08/485,219, filed June 7, 1995, now U.S. Patent No. 5,697,281, which is a continuation-in-part of Application No. 08/446,767 filed June 2, 1995, now U.S. Patent No. 5,697,909 which is a U.S. National Phase Filing of International Application No. PCT/US94/05168, filed May 10, 1994, which is a continuation-in-part of Application No. 08/059,681, filed May 10, 1993, now abandoned, which is a continuation-in-part of Application No. 07/958,977, filed October 9, 1992, now U.S. Patent No. 5,366,443, which is a continuation-in-part of Application No.

* division of Application No. 081795,686, filed February 5, 1997, now U.S. Pat. No. 5,874,469, which is a division of Application No. 081561,958, filed Nov. 22, 1995, now U.S. Pat. No. 5,697,882, which is a

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